



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Michael A. Lamson, et al.

TI No.: 28674

Serial No.: 09/631,198

Art Unit: 2814

Filed: 08/03/2000

Examiner: Nguyen, Binh P.

For: Structure And Method Of High Performance
Two Layer Ball Grid Array Substrate

Conf. No.: 9326

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J. Carter


NOTICE OF APPEAL

Assistant Commissioner For Patents
Washington, DC 20231

Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that the above correspondence is being deposited with the US Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, DC 20231.


Elizabeth Austin

3/6/2003
Date

Applicant hereby appeals to the Board of Appeals from the decision dated November 6, 2002 of the Primary Examiner finally rejecting Claims 30-36.

Charge the fee of \$320.00 to the deposit account of Texas Instruments Incorporated, Account No. 20-0668. An original and two copies of this sheet are enclosed.

03/13/2003 MDAMTE1 00000006 200668 09631198

02 FC:1401 320.00 CH

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Respectfully submitted,



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